

UHF low voltage variable capacitance diode Rev. 3 — 6 September 2011

Product data sheet

1. **Product profile**

1.1 General description

The BB184 is a variable capacitance diode, fabricated in planar technology, and encapsulated in the SOD523 (SC-79) ultra small SMD plastic package.

1.2 Features and benefits

- Very steep CV curve
- C_{d(1V)}: 14 pF; C_{d(10V)}: 2 pF
- C_{d(1V)} to C_{d(10V)} ratio: typical 7
- Ultra small SMD plastic package.

1.3 Applications

- Voltage Controlled Oscillators (VCO)
- Tuning in low voltage television.

Pinning information 2.

Table 1. Discrete pinning

Pin	Description	Simplified outline	Symbol
1	cathode	<u></u>	JL.
2	anode	1 2	sym008

Ordering information 3.

Table 2. **Ordering information**

Type number	Package		
	Name	Description	Version
BB184	-	plastic surface mounted package; 2 leads	SOD523

Marking 4.

Table 3. **Marking**

Type number	Marking code
BB184	A2



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5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{R}	continuous reverse voltage		-	13	V
I _F	continuous forward current		-	10	mA
T _{stg}	storage temperature		-55	+150	°C
Tj	operating junction temperature		-55	+125	°C

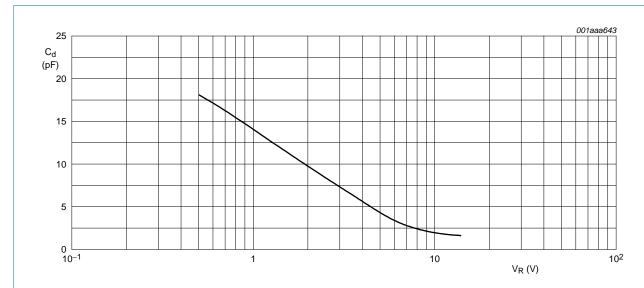
6. Characteristics

Table 5. Electrical characteristics

 $T_i = 25$ °C unless otherwise specified.

Parameter	Conditions	Min	Тур	Max	Unit
reverse current	V _R = 10 V; see <u>Figure 2</u>	-	-	10	nΑ
	V _R = 10 V; T _j = 85 °C; see <u>Figure 2</u>	-	-	200	nΑ
diode series resistance	f = 470 MHz; C _d = 9 pF	-	0.65	-	Ω
diode capacitance	f = 1 MHz; see Figure 1 and 3				
	V _R = 1 V	12.7	14	15.3	pF
	V _R = 4 V	-	5.5	-	pF
	V _R = 10 V	1.87	2	2.13	pF
capacitance ratio	f = 1 MHz	6	7	-	
capacitance matching	$V_R = 1$ to 10 V; in a sequence of 5 diodes (gliding)	-	-	2	%
	reverse current diode series resistance diode capacitance capacitance ratio	reverse current $V_R = 10 \text{ V}; \text{ see } \underline{\text{Figure 2}}$ $V_R = 10 \text{ V}; T_j = 85 \text{ °C}; \text{ see } \underline{\text{Figure 2}}$ $\text{diode series resistance} \qquad f = 470 \text{ MHz}; C_d = 9 \text{ pF}$ $\text{diode capacitance} \qquad f = 1 \text{ MHz}; \text{ see } \underline{\text{Figure 1}} \text{ and } \underline{3}$ $V_R = 1 \text{ V}$ $V_R = 4 \text{ V}$ $V_R = 10 \text{ V}$ $\text{capacitance ratio} \qquad f = 1 \text{ MHz}$ $\text{capacitance matching} \qquad V_R = 1 \text{ to 10 V}; \text{ in a sequence of 5 diodes}$	reverse current $\begin{array}{c} V_R = 10 \text{ V}; \text{ see } \underline{\text{Figure 2}} & - \\ V_R = 10 \text{ V}; T_j = 85 \text{ °C}; \text{ see } \underline{\text{Figure 2}} & - \\ \text{diode series resistance} & f = 470 \text{ MHz}; C_d = 9 \text{ pF} & - \\ \text{diode capacitance} & f = 1 \text{ MHz}; \text{ see } \underline{\text{Figure 1}} \text{ and } \underline{3} \\ V_R = 1 \text{ V} & 12.7 \\ V_R = 4 \text{ V} & - \\ V_R = 10 \text{ V} & 1.87 \\ \text{capacitance ratio} & f = 1 \text{ MHz} & 6 \\ \\ \text{capacitance matching} & V_R = 1 \text{ to 10 V}; \text{ in a sequence of 5 diodes} & - \\ \end{array}$	reverse current $\begin{array}{c} V_R = 10 \text{ V}; \text{ see } \underline{\text{Figure 2}} & - & - \\ V_R = 10 \text{ V}; T_j = 85 \text{ °C}; \text{ see } \underline{\text{Figure 2}} & - & - \\ \\ \text{diode series resistance} & f = 470 \text{ MHz}; C_d = 9 \text{ pF} & - & 0.65 \\ \\ \text{diode capacitance} & f = 1 \text{ MHz}; \text{ see } \underline{\text{Figure 1}} \text{ and } \underline{3} \\ \\ V_R = 1 \text{ V} & 12.7 & 14 \\ \\ V_R = 4 \text{ V} & - & 5.5 \\ \\ V_R = 10 \text{ V} & 1.87 & 2 \\ \\ \text{capacitance ratio} & f = 1 \text{ MHz} & 6 & 7 \\ \\ \\ \text{capacitance matching} & V_R = 1 \text{ to } 10 \text{ V}; \text{ in a sequence of 5 diodes} & - & - \\ \\ \end{array}$	reverse current $\begin{array}{c ccccccccccccccccccccccccccccccccccc$

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 $f = 1 \text{ MHz}; T_j = 25 \text{ }^{\circ}\text{C}.$

Fig 1. Diode capacitance as a function of reverse voltage; typical values.

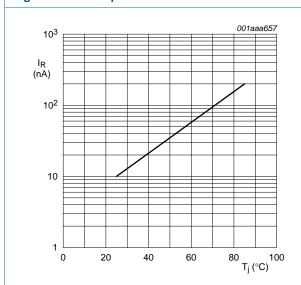


Fig 2. Reverse current as a function of junction temperature; maximum values.

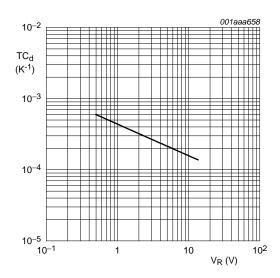


Fig 3. Temperature coefficient of diode capacitance as a function of reverse voltage; typical values.

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7. Package outline

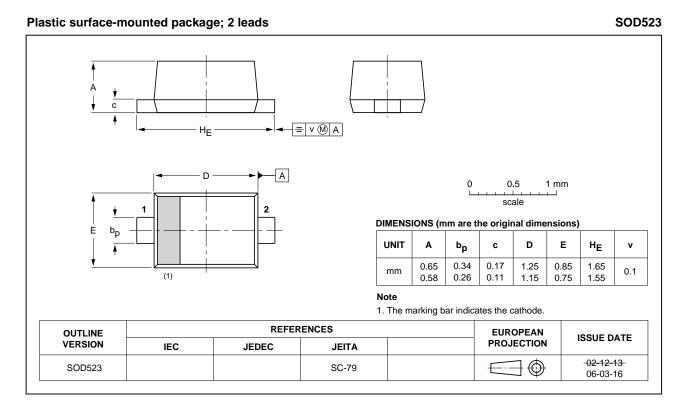


Fig 4. Package outline.

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8. Revision history

Table 6. Revision history

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Document ID	Release date	Data sheet status	Change notice	Supersedes
BB184 v.3	20110906	Product data sheet	-	BB184 v.2
Modifications:	guidelines • Legal texts	of this data sheet has beer of NXP Semiconductors. have been adapted to the i utline drawings have been u	new company name whe	ere appropriate.
BB184 v.2 (9397 750 13004)	20040422	Product data	-	BB184_N v.1
BB184_N v.1 (9397 750 12694)	20040114	Preliminary data	-	-

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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